

S25	442	((("438/612").CCLS.) (("438/614").CCLS.) ("438/382"). CCLS.) ("438/384").CCLS.)) and (separat\$4)	USPAT	OR	OFF	2001/06/19 11:25
S26	89	((("438/612").CCLS.) (("438/614").CCLS.) ("438/382"). CCLS.) ("438/384").CCLS.)) and (separat\$4 near5 substrate)	USPAT	OR	OFF	2001/06/19 13:06
S31	1	("6376332").PN.	USPAT	OR	OFF	2005/01/10 10:03
S32	621	(438/455).CCLS.	USPAT	OR	OFF	2005/01/10 12:52
S33	62367	(composite or (bonded near3 substrate)) and project\$3 and separat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 12:51
S34	540	(composite or (bonded near3 substrate)) and project\$3 and separat\$3 and single?crystal	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 12:51
S35	204	(composite or (bonded near3 substrate)) and project\$3 and separat\$3 and single?crystal and porous	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 13:12
S36	621	(438/455).CCLS.	USPAT	OR	OFF	2005/01/10 12:52
S37	17	S35 and S36	USPAT	OR	OFF	2005/01/10 13:10
S38	142137	"428"/\$.ccls.	USPAT	OR	OFF	2005/01/10 13:10
S39	5	S35 and S38	USPAT	OR	OFF	2005/01/10 13:10
S40	5	S39 not S37	USPAT	OR	OFF	2005/01/10 13:10
S41	148	(composite or (bonded near3 substrate)) and project\$3 and separat\$3 and single?crystal and porous and transfer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 13:13
S42	60	(composite or (bonded near3 substrate)) and project\$3 and separat\$3 and single?crystal and porous and transfer near3 layer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 14:22
S43	0	boned near3 substrate near3 stack	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 14:22

S44	251	bonded near3 substrate near3 stack	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 14:22
S45	918497	bonded near3 substrate near3 stack periphery	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 14:22
S46	63	bonded near3 substrate near3 stack and periphery	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 14:22
S47	1720494	bonded near3 substrate near3 stack and periphery project\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 14:22
S48	15	bonded near3 substrate near3 stack and periphery and project\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 14:25
S49	64	bonded near3 substrate near3 stack and outer and edge	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 14:25
S50	53	S49 not S48	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/10 14:25